ASSOCIATION CONNECTING ELECTROMICS INDUSTRIES INDUSTRIES	nockburn, Illinois. A	ll rights reserved und ations.	ler both lev	nis docume vel parts, th	ent is a declarati he declaration e	on of the sub ncompasses	ostances v all lower	within the manufacture level materials for wh	er listed it hich the m	em. Note: if anufacturer	f the item is an as has engineering	sembly with lower responsibility.
	IPC Web Site for Information on IPC-1752 Standard Form Typ http://www.ipc.org/IPC-175x Distribute			* Declaration Class * Class 6 - RoHS Yes/No, Homogeneous Material					als and Mfg Information			
Supplier Information												
npany name* Company unique ID				Unique ID Authority					Response Date*			
onsemi	ni							2024-04-25				
Contact Name	e Title - Contact			I	Phone - Contact*				Email - Contact*			
Product-Env-Stewards	ct-Env-Stewards Product Enviro Compliance			NA				Product-Env-Stewards@onsemi.com				
Authorized Representative*	uthorized Representative* Title - Representative			Phone - Representative*				Email - Representative*				
Product-Env-Stewards Product Enviro Compliance			NA				Product-Env-Stewards@onsemi.com					
Requester Item Number Mf	r Item Number	Mfr Item Name			Effective Date	Version	М	Manufacturing Site		Veight*	UOM	Unit Type
NC TA	CV8187AMTWADJ G	8187AMTWADJ 1.2 A Low Iq, Low Regulator with Powe		e	2024-04-25		T	H6	9	9.47	mg	Each
Manufacturing Proccess Information												
Terminal Plating / Grid Array Material	Terminal Base Alloy J		TD-020 MSL R	ating	Peak Proc	ess Body Ter	mperature	e Max Time at Peak	Temperati	ure Numb	er of Reflow Cyc	eles
Matte Tin (Sn) - annealed CU Alloy 1				260		С	30	second	ds 3			
Comments												
level 1 - maximum time at peak temperature duri	ng soldering is 10-3	0 seconds										
For more information regarding material compos	sition please refer to	page 3										

RoHS Material Composition Declaration				Declaration Type *	Detailed					
Directive 2015/863/EU amending RoHS Directive 2011/65/EU	RoHS Definition: Quantity limit of 0.01% by mass (100 PPM) in homogeneous material for Cadmium and quantity limit of 0.1% by mass (1000 PPM) in homogeneous material for: Lead (Pb), Mercury (Hg), Hexavalent Chromium (Cr6+), Polybrominated Biphenyls (PBB), Polybrominated Diphenyl Ethers (PBDE), and Bis(2-ethylhexyl) phthalate (DEHP), Benzyl-butyl phthalate (BBP), Dibutyl phthalate (DBP), Disobutyl phthalate (DIBP).									
cadmium, hexavalentchromium, polybrominate contains a RoHS restricted substance inexcess encompass all such components. Supplier certif as of the date that Supplier completes this form Company acknowledges that Supplier may hav independently verified information provided by certification in this paragraph. If the Company a	ed biphenyls and/or polybrominated dip of an applicable quantity limit, please ir ies that it gathered the information it pro- .Supplier acknowledges that Company e relied on informationprovided by othe v others, Supplier agrees that, at a minin and the Supplier enter into a written agre pource of the Supplier's liability and the	henyl ethers (each a " ndicate below which, i ovides in this form us will rely on this certifiers in completing this num, itssuppliers have eement with respect to Company's remedies	RoHS restricted substance") in exce if any, RoHS exemption you believe ing appropriate methods to ensure if ication in determining the complian form, and that Supplier may not have e provided certifications regarding the to the identified part, the terms and co for issues that arise regarding inform	ce of its products with European Union membe	ove. If a homogeneous material within the part er level components, the declaration shall l correct to the best of its knowledge and belief, r state laws that implement the RoHS Directive. wever, in situations where Supplier has not tions are at least as comprehensive as the anty rights and/or remedies provided as part of					
RoHS Declaration * 1 - Item(s)	does not contain RoHS restricted substa	on above	Supplier Acceptance	* Accepted						
Exemption: If the declared item does not con applicable exemptions.	ntain RoHS restricted substances per	the definition above	except for defined RoHS exempti	ons, then select the corresponding response i	n the RoHS Declaration above and choose all					
Exemption List Version	EL-2011/534/EU									
Declaration Signature										
Instructions: Complete all of the required fin Requester) and click on Submit Form to have	elds on all pages of this form. Select the form returned to the Requester	he "Accepted" on th	e Supplier Acceptance drop-down	. This will display the signature area. Digital	lly sign the declaration (if required by the					
Supplier Digital Signature Ra	stislav Drska	Le								

## Homogeneous Material Composition Declaration for Electronic Products

SubItem Instructions: The presence of any JIG Level A or B substances must be declared. [1] indicate the subpart in which the substance is located, [2] provide a description of the homogeneous material [3], enter the weight of the homogeneous material.

Homogeneous Material	Weight	Unit of Measure	Level	Substance	CAS	Exempt	Weight	Unit of Measure
Die	0.44	mg	Supplier	Silicon (Si)	7440-21-3		0.44	mg
Die Attach	0.1	mg	Supplier	Isobornyl Methacrylate	7534-94-3		0.006	mg
			Supplier	Silver (Ag)	7440-22-4		0.0815	mg
			Supplier	Isobornyl Acrylate	5888-33-5		0.006	mg
			Supplier	Misc.	Proprietary Data		0.0005	mg
			Supplier	Tricyclo[5.2.1.02,6]decanedimethanol Diacrylate (C18H24O4)	42594-17-2		0.006	mg
Lead Frame	2.65	mg	Supplier	Zinc (Zn)	7440-66-6		0.0032	mg
			Supplier	Iron (Fe)	7439-89-6		0.0623	mg
			Supplier	Copper (Cu)	7440-50-8		2.5838	mg
			Supplier	Phosphorus (P)	7723-14-0		0.0008	mg
Lead Frame plating	0.05	mg	Supplier	Silver (Ag)	7440-22-4		0.05	mg
Mold Compound-Black	5.53	mg		Epoxy resin	proprietary data		0.2765	mg
			Supplier	Phenolic Resin	Proprietary Data		0.1272	mg
			Supplier	Silica Amorphous (SiO2)	7631-86-9		0.2765	mg
			Supplier	Carbon Black (C)	1333-86-4		0.0221	mg
			Supplier	Aluminum Hydroxide (Al(OH)3)	21645-51-2		0.1272	mg
			Supplier	Fused Silica (SiO2)	60676-86-0		4.7005	mg
Plating	0.39	mg	Supplier	Tin (Sn)	7440-31-5		0.39	mg
Wire Bond - Au	0.31	mg	Supplier	Gold (Au)	7440-57-5		0.31	mg